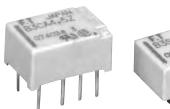


ULTRA MINIATURE RELAY 2 POLES - 2 A (Low Profile Signal Relay)

FTR-B3 Series

FEATURES

- DPDT 2C
- Ultra miniature low profile relay with high heat resistant material
- Height: 5.45mm, Weight: 0.85q, Mounting space: 87mm2
- Adopted superior contact spring for high frequency characteristic
- Comply with Telcordia / FCC standard
 - Isolation distance: min. 1.6mm
 - Dielectric strength between coil and contact: 1500VAC
 - Surge strength: 2500V
- Low power: Non-latching: 140mW (230mW at 24V) Latching: 100mW (120mW at 24V)
- High reliable bifurcated gold overlay silver contact
- UL, CSA recognized. Confirms to IEC 60950, UL1950, EN60950. Spacing & high breakdown voltage (basic insulation, 150 working volts, pollution degree 2)
- RoHS compliant.
 - Please see page 9 for more information





PARTNUMBER INFORMATION

(a)	Relay type	FTR-B3	: FTR-B3-Series
(b)	Terminal type	C G S	: Through hole : Surface mount : Surface mount, space saving
(c)	Coil type	A B	: Standard type : Latching type (1 coil)
(d)	Coil rated voltage	012	: 1.524 VDC Coil rating table at page 3
(e)	Contact material	Z P	: Gold overlay silver nickel : Gold overlay silver palladium
(f)	Relay enclosing direction *1	В	: Standard enclosing direction
(g)	Number of relays per reel *2	10	: 1,000 (standard)

Remarks: Actual marking on relay would not carry code FTR and be as below: Ordering code: FTR-B3GB012Z-B10 Actual marking: B3GB012Z

^{* 1} Only surface mount types (G and S) are applicable

^{* 2} All relays are packaged in tubes unless part number ends with -B10 (50 relays per tube).

■ SPECIFICATION

Item			Standard type	Latching type	
			FTR-B3 () A	FTR-B3 () B	
Contact Data	Configuration		2 form C		
	Construction		Bifurcated contacts (cross-bar)		
	Material		Gold overlay silver nickel / Gold overlay silver palladium		
	Resistance (initial)		Max. 75 mΩ at 1 A, 6 VDC		
	Contact rating (resistive)		30VDC, 1A / 125VAC, 0.3A		
	Max. carrying current		2A		
	Max. switching voltage		250 VAC / 220VDC		
	Max. switching power		62.5VA / 30W		
	Min. switching load *		0.01mA, 10mVDC		
Life	Mechanical		Min. 50 x 10 ⁶ operations (at 3Hz)	Min. 20 x 10 ⁶ operations (at 3Hz)	
	Electrical		Min. 100 x 10 ³ operations at 1A 30VDC (at 0.5Hz) Min. 100 x 10 ³ operations at 0.3A 125VAC (at 0.5Hz)		
Coil Data	Rated power		140mW - 230mW	100mW - 120mW	
	Operate power		80mW - 130mW	57mW - 68mW	
	Operating temperature ra	inge	-40 °C to +85 °C (no frost)		
Timing Data	Operate (at nominal volta	age)	Max. 3 ms (without bounce)		
	Release (at nominal volta	age)	Max. 3 ms (without bounce)		
Insulation	Resistance (initial)		Min. 1,000MΩ at 500VDC		
		Open contacts	1,000VAC (50/60Hz) 1min		
	Dielectric strength	Adjacent contacts	1,000VAC (50/60Hz) 1min.		
		Contacts to coil	1,500VAC (50/60Hz) 1min		
	Surge strength	Contacts to coil	2,500V, 2 x 10µs standard wave		
		Open contacts	0.28 mm		
	Clearance	Adjacent contacts	1.0 mm		
		Contacts to coil	1.0 mm		
		Open contacts	0.28 mm		
	Creepage	Adjacent contacts	1.0 mm		
		Contacts to coil	1.60 mm		
Other	Vibration resistance	Misoperation	10 to 55Hz double amplitude 3.3mm		
	violation resistance	Endurance	10 to 55Hz double amplitude 5.0mm		
	Shock	Misoperation	750m/s²		
	SHUCK	Endurance	1,000m/s ²		
	Weight		Approximately 0.8 g		

^{*} Minimum switching loads mentioned above are reference values. Please perform the confirmation test with actual load before production since reference values may vary according to switching frequencies, environmental conditions and expected reliability levels.

COIL RATING

Standard type

Coil Code	Rated Coil Voltage (VDC)	Coil Resistance +/- 10% (Ohm)	Must Operate Voltage (VDC) *	Must Release Voltage (VDC) *	Rated Power (mW)
1.5	1.5	16.1	1.13	0.15	
003	3	64.3	2.25	0.3	
4.5	4.5	145	3.38	0.45	140
006	6	257	4.5	0.6	
009	9	579	6.75	0.9	
012	12	1,028	9.0	1.2	
024	24	2,504	18.0	2.4	230

Latching type (1 coil)

Coil Code	Rated Coil Voltage (VDC)	Coil Resistance +/- 10% (Ohm)	Set Voltage (VDC) *	Reset Voltage (VDC) *	Set/Reset current (mA)	Rated Power (mW)
1.5	1.5	22.5	+1.13	-1.13	50	
003	3	90	+2.25	-2.25	25	
4.5	4.5	203	+3.38	-3.38	17	
006	6	360	+4.5	-4.5	13	100
009	9	810	+6.75	-6.75	8	
012	12	1,440	+9.0	-9.0	6	
024	24	4,800	+18.0	-18.0	4	120

Note: All values in the table are valid for 20°C and zero contact current. * Specified operate values are valid for pulse wave voltage.

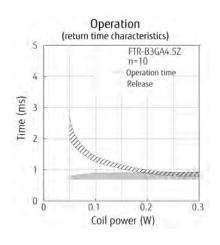
SAFETY STANDARDS

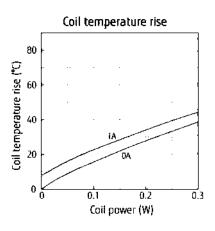
Туре	Compliance	Contact rating	
UL	UL 508	Flammability: UL 94-V0 (plastics)	
	E 63615	0.5A, 125VAC (resistive) 1A, 30VDC (resistive)	
CSA	C22.2 No. 14 LR 40304-58	0.3A, 110VDC (resistive) 2A, 30VDC (resistive)	

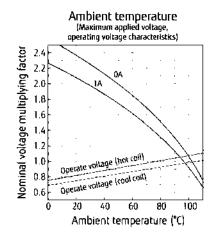
Comply with Telcordia specifications and FCC part 68 and meet BSI EN60950-1:2006 Marking only for UL, CSA $\,$

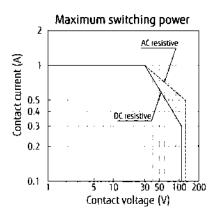
■ CHARACTERISTIC DATA

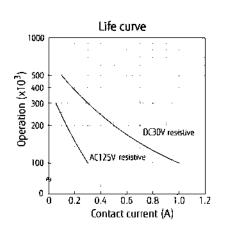
Standard type

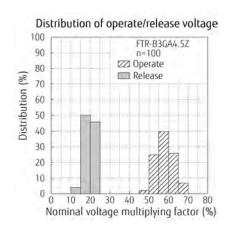


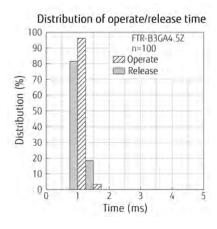


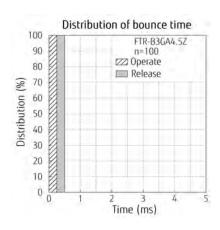


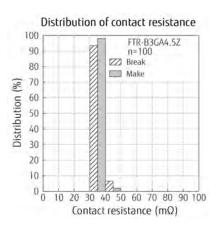


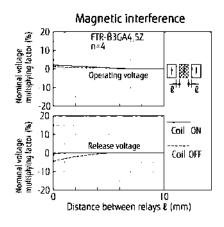


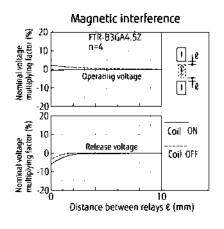


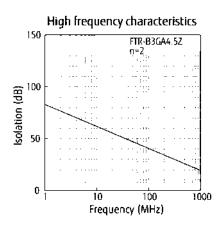


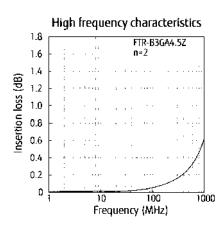




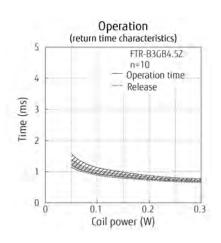


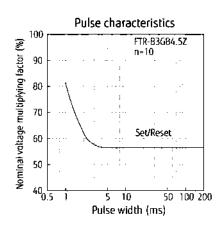


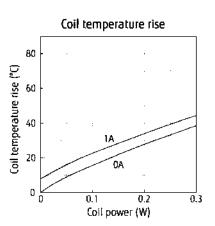


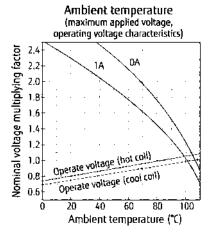


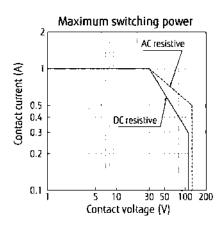
Latching type

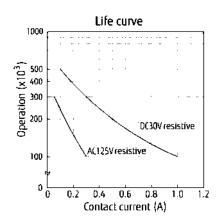


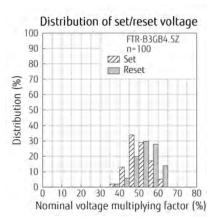


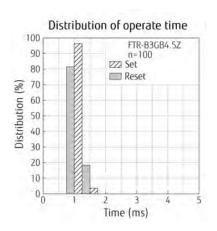


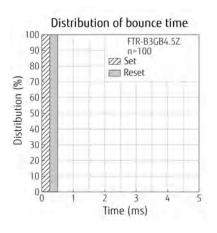


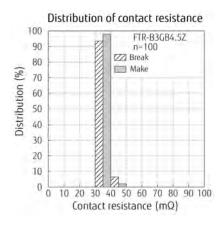


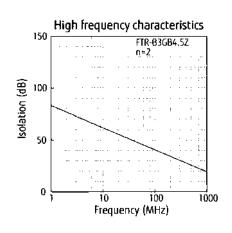


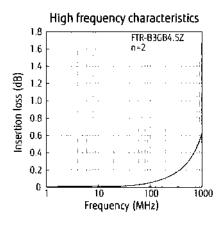








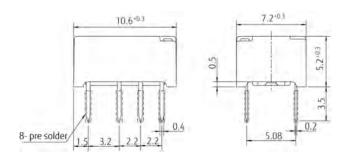




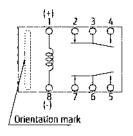
DIMENSIONS

FTR-B3C - Through hole type

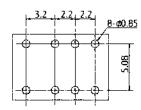
Dimensions



Schematics * (BOTTOM VIEW)

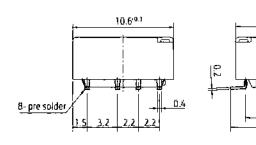


 PC board mounting hole layout (BOTTOM VIEW)

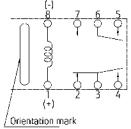


FTR-B3G - Surface mount type

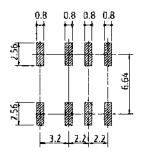
Dimensions



• Schematics * (TOP VIEW)

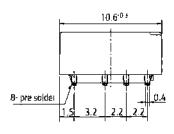


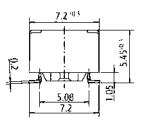
PC board mounting pad layout (TOP VIEW)



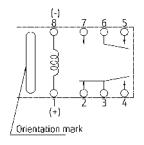
FTR-B3S - Space saving type

Dimensions

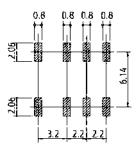




Schematics * (TOP VIEW)



 PC board mounting pad layout (TOP VIEW)



Unit: mm

^{*} Indicates reset state for latching relays (FTR-B3CB, FTR-B3GB and FTR-B3SB versions) Indicates non-operate state for standard relays (FTR-B3CA, FTR-B3GA and FTR-B3SA versions)

COIL POLARITY LATCHING TYPE

Coil terminal	1	8
Set	+	-
Reset	-	+

RECOMMENDED SOLDERING CONDITIONS FOR SMT (SEE PAGE 9) (TEMPERATURE PROFILE)

Notes:

1. Temperature profiles on page 9 show the temperature of PC board surface.

2. Please perform soldering test with your actual PC board before mass production, since the temperatures of PC board surfaces vary according to the size of PC board, status of parts mounting and heating method.

PRECAUTIONS

For details on general precautions, refer to the section on technical descriptions.
Since this is a polarized relay, follow the instructions of the internal wiring diagram for the ± connections of the coil.

- Note that the terminal layout and internal wiring of the surface mount relay are a top view.

- SMT versions of the FTR-B3 relays will be shipped in "dry pack".

PACKAGING SPECIFICATIONS

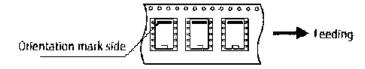
Packaging method

- Packaging standard: JIS C 0806

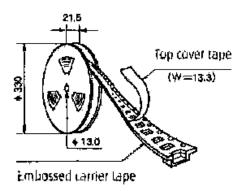
- Taping type: TB 1612 - Reel type: R16D

- Quantity of 1 reel: 1000 pieces

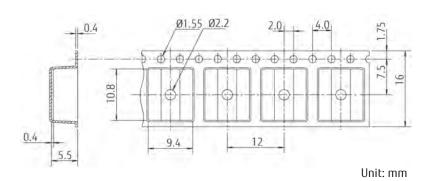
Packaging orientation code: B



Reel dimensions



Tape dimensions



Relays are sold in 1000 pieces per box. Minimum order quantity is 1000 pieces for tube and tape & reel packing.

RoHS Compliance and Lead Free Information

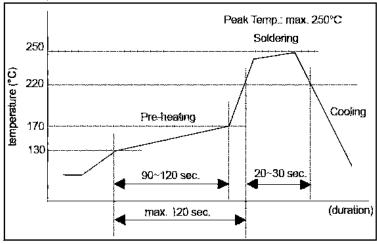
1. General Information

- All relays produced by Fujitsu Components are compliant with RoHS directive 2011/65/EU including amendments.
- Cadmium as used in electrical contacts is exempted from the RoHS directives.
 As per Annex III of directive 2011/65/EU.
- All relays are lead-free. Please refer to Lead-Free Status Info for older date codes at: http://www.fujitsu.com/downloads/MICRO/fcai/relays/lead-free-letter.pdf
- Lead free solder plating on relay terminals is Sn-3.0Ag-0.5Cu, unless otherwise specified. This material has been verified to be compatible with PbSn assembly process.

2. Recommended Lead Free Solder Condition

• Recommended solder Sn-3.0Ag-0.5Cu.

Reflow Solder condition



Flow Solder Condition:

Pre-heating: maximum 120°C

within 9 sec.

Soldering: dip within 5 sec. at

255°C ± 5°C solder bath

Relay must be cooled by air immediately

after soldering

Solder by Soldering Iron:

Soldering Iron 30-60W

Temperature: maximum 350-360°C Duration: maximum 3 sec.

We highly recommend that you confirm your actual solder conditions

3. Moisture Sensitivity

• Moisture Sensitivity Level standard is not applicable to electromechanical relays, unless otherwise indicated.

4. Tin Whiskers

• Dipped SnAgCu solder is known as presenting a low risk to tin whisker development. No considerable length whisker was found by our in house test.

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